

7-18-06

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EXPRESS MAIL NO.: EV822350416US DATE MAILED: July 11, 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Yi-Shung CHAUG, *et al.*

Appl. No. 10/665,992

Filed: September 19, 2003

For: PROCESS FOR FORMING A
PATTERNEDE THIN FILM
STRUCTURE FOR IN-MOLD
DECORATION

Art Unit: 1734

Confirmation No.: 5386

Examiner: Chan, Sing P

Attorney Docket: 07783.0101.CPUS01

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to enter
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SPC

RESPONSE TO FINAL OFFICE ACTION

MAIL STOP: AF
Commissions for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

This is in response to the Final Office Action dated May 16, 2006, and is submitted within two months of the mailing date of the Final Office Action. The Examiner is requested to enter the amendments and reconsider the application.

The U.S. Patent and Trademark Office is hereby authorized to charge any fee deficiency, including fees under §1.17; or credit any overpayment, to our Deposit Account No. 08-3038 referencing Atty. Dkt. No. 07783.0101.CPUS01.